

### November 2013

# FDP039N08B N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 171 A, 3.9 m $\Omega$

## **Features**

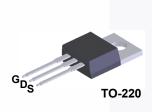
- $R_{DS(on)}$  = 3.16 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V, I<sub>D</sub> = 100 A
- Low FOM R<sub>DS(on)</sub> \* Q<sub>G</sub>
- Low Reverse-Recovery Charge, Q<sub>rr</sub> = 87.9 nC
- Soft Reverse-Recovery Body Diode
- Enables High Efficiency in Synchronous Rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

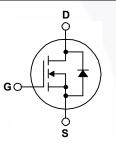
## Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor Drives and Uninterruptible Power Supplies





## Absolute Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

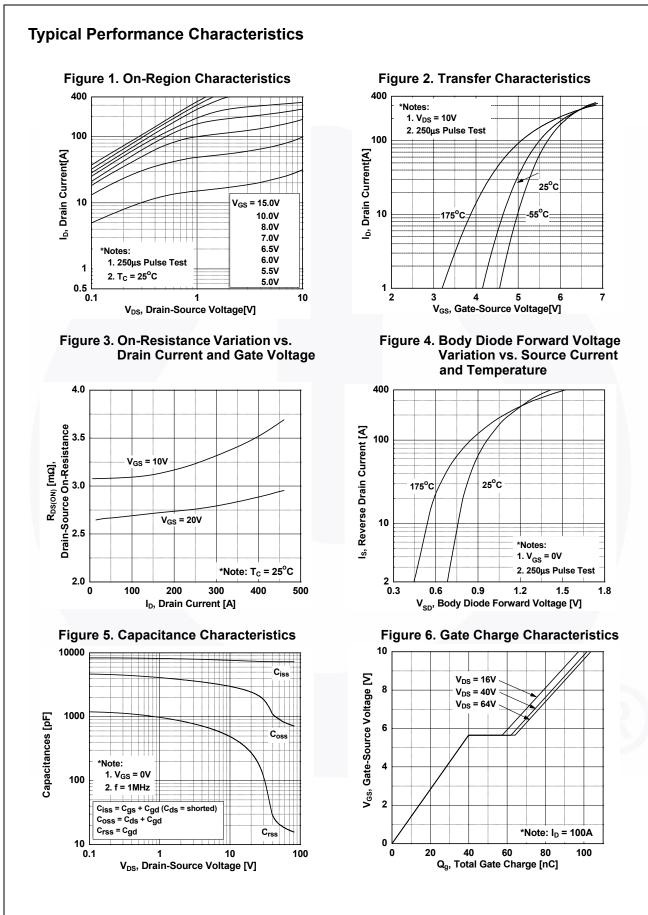
Symbol		FDP039N08B_F102	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	80	V		
V <sub>GSS</sub>	Gate to Source Voltage		±20	V	
I <sub>D</sub>		- Continuous (T <sub>C</sub> = 25°C, Silicon Limited)	l) 171*		
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, Silicon Limited)	121*	A	
		- Continuous (T <sub>C</sub> = 25°C, Package Limited)	120		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	684	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy	547	mJ		
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P <sub>D</sub>	Power Dissinction	(T <sub>C</sub> = 25°C)	214	W	
	Power Dissipation	- Derate Above 25°C	1.43	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temperature for	Soldering, 1/8" from Case for 5 Seconds	300	°C	

\* Package limitation current is 120A.

## **Thermal Characteristics**

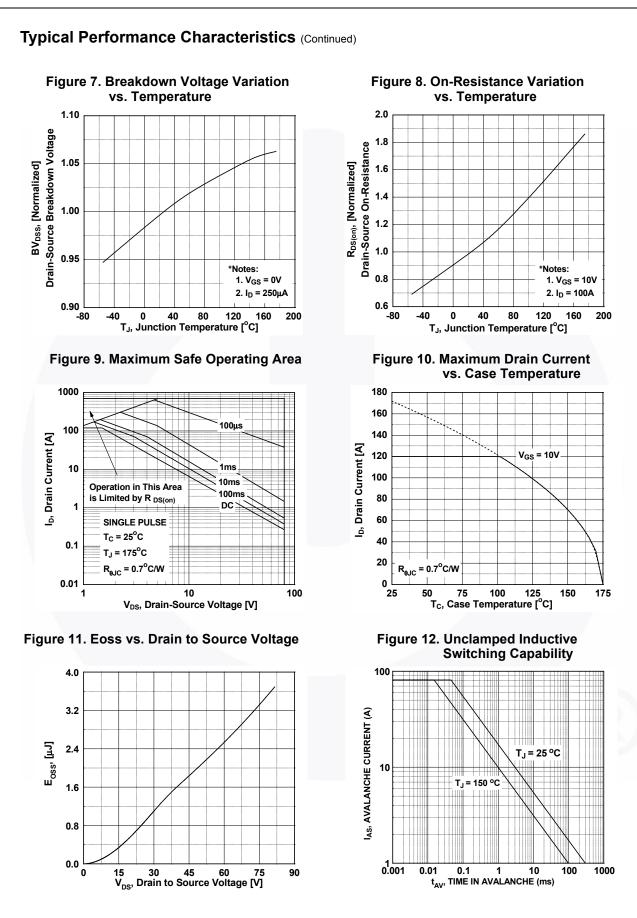
Symbol	Parameter	FDP039N08B_F102	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.7	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	0/00

			Package	Packing Method	Reel Size	Тар	be Width	Qua	ntity
FDP039N08E			TO-220	Tube	N/A		N/A	50 units	
Electrical	Chara	acteristics T <sub>c</sub> =	25ºC unless	otherwise noted.					
Symbol	Parameter			Test Conditions		Min.	Тур.	Max.	Unit
Off Charact	eristics	5							
BV <sub>DSS</sub>	Drain to	Source Breakdown V	oltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0	V	80	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Drain to Source Breakdown Voltage Breakdown Voltage Temperature Coefficient		0	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0.7$ $I_D = 250 \ \mu\text{A}, \ \text{Referenced to } 25^{\circ}\text{C}$		-	0.089	-	V/ºC
/				V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V		-	-	1	
DSS	Zero Ga	ero Gate Voltage Drain Current		$V_{DS} = 64 \text{ V}, T_{C} = 150^{\circ}\text{C}$		-	-	500	μA
GSS	Gate to I	Body Leakage Currer	nt	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$		-	-	±100	nA
On Charact	eristics								
V <sub>GS(th)</sub>	Gate Th	reshold Voltage		V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 µ	A	2.5	-	4.5	V
R <sub>DS(on)</sub>		ain to Source On Res	sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ J}$		-	3.16	3.9	mΩ
JFS	Forward Transconductance			$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$		-	180	-	S
Dynamic Cl	haracte	ristics					1		
C <sub>iss</sub>	1	but Capacitance				-	7105	9450	pF
C <sub>OSS</sub>		Capacitance		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, f = 1 MHz		-	1110	1475	pF
		Transfer Capacitance	Э			-	30	-	pF
Coss(er)	Energy Related Output Capacitance			V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V		-	1656	-	pF
$Q_{g(tot)}$		Total Gate Charge at 10V   Gate to Source Gate Charge   Gate to Drain "Miller" Charge   Gate Plateau Volatge		$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 100 \text{ A},$ $V_{GS} = 10 \text{ V}$ (Note 4)		-	102	133	nC
$\hat{\boldsymbol{\lambda}}_{gs}$	Gate to S					-	39.9	-	nC
Ω <sub>gd</sub>	Gate to I					-	22	-	nC
√ <sub>plateau</sub>	Gate Pla					-	5.6	-	V
Q <sub>sync</sub>	Total Gate Charge Sync.			V <sub>DS</sub> = 0 V, I <sub>D</sub> = 50 A		-	87.4	-	nC
Q <sub>oss</sub>	Output Charge			$V_{DS}$ = 40 V, $V_{GS}$ = 0 V		-	99.2	-	nC
Switching C	Charact	eristics							
d(on)	Turn-On	Delay Time		$V_{DD}$ = 40 V, I <sub>D</sub> = 100 A, V <sub>GS</sub> = 10 V, R <sub>G</sub> = 4.7 Ω (Note 4)		-	36	82	ns
r	Turn-On	Rise Time				-	49	108	ns
d(off)	Turn-Off	Delay Time				<i>7</i> -	71	152	ns
f	Turn-Off	Fall Time				-	29	68	ns
ESR	Equivale	nt Series Resistance	(G-S)	f = 1 MHz		-	2.2	-	Ω
Drain-Sour	ce Diod	e Characteristic	S						
S	Maximun	n Continuous Drain to	Source Diode	de Forward Current		-	-	171*	Α
SM	Maximun	n Pulsed Drain to Sou	Irce Diode For	orward Current		-	-	684	Α
/ <sub>SD</sub>	Drain to	Source Diode Forwar	d Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 100 A		-	-	1.3	V
rr	Reverse Recovery Time			V <sub>GS</sub> = 0 V, V <sub>DD</sub> = 40 V, I <sub>SD</sub> = 100 A,		-	70.1		ns
2 <sup>m</sup>	Reverse Recovery Charge			dI <sub>F</sub> /dt = 100 A/µs		-	87.9		nC

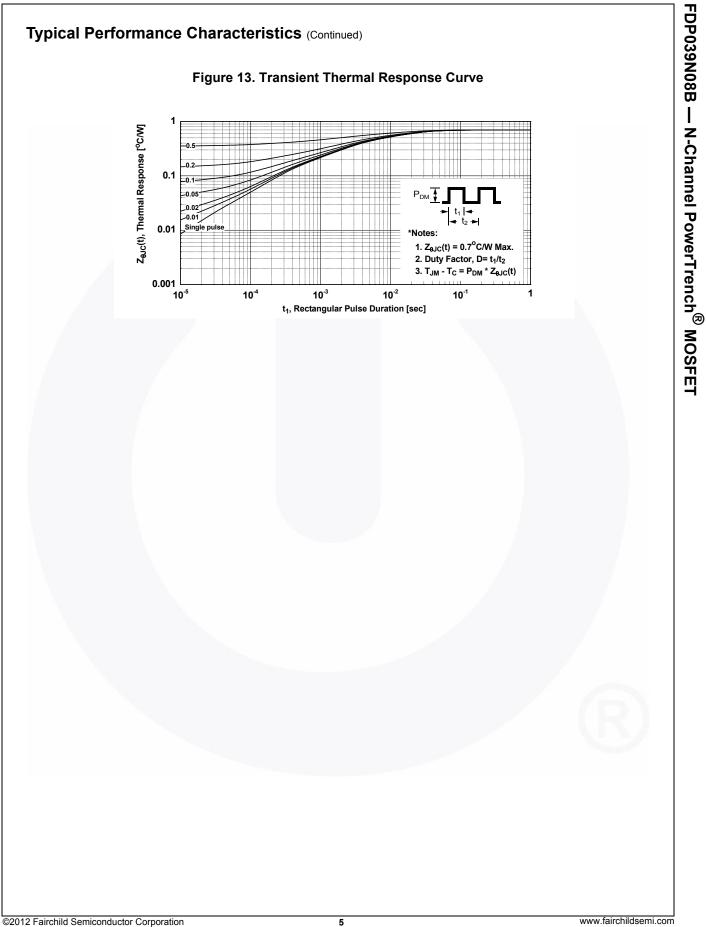


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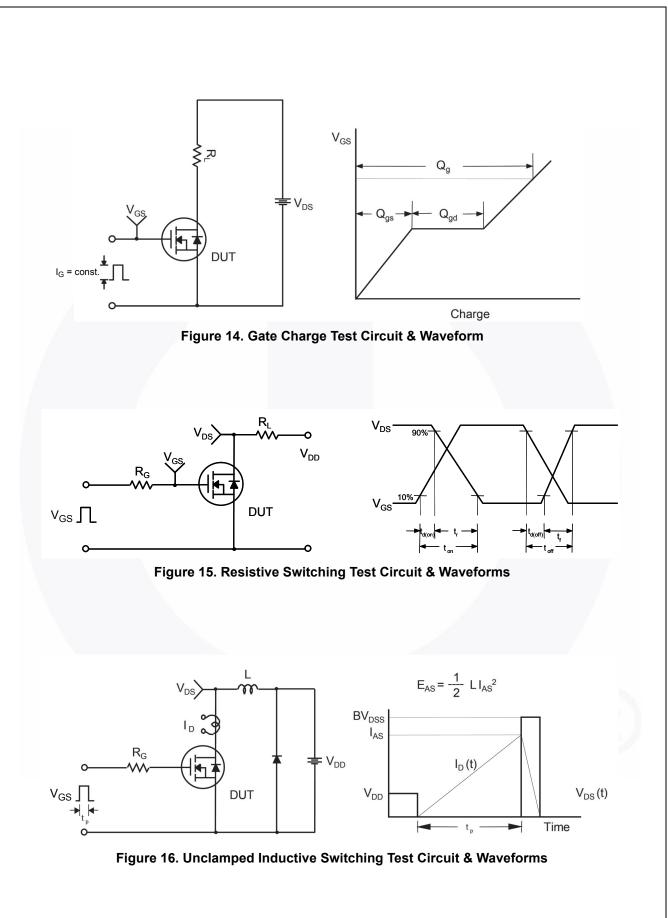




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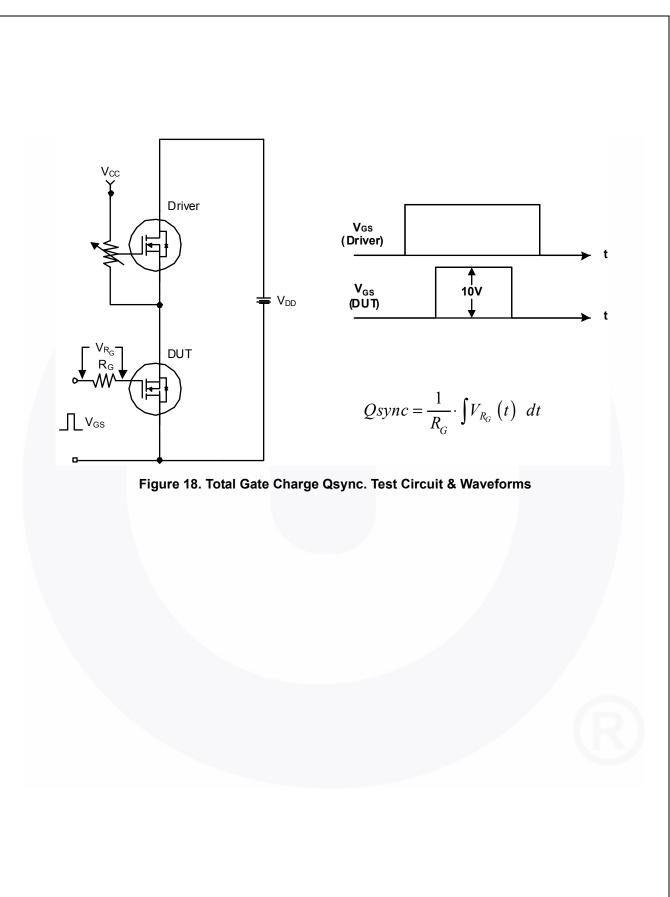
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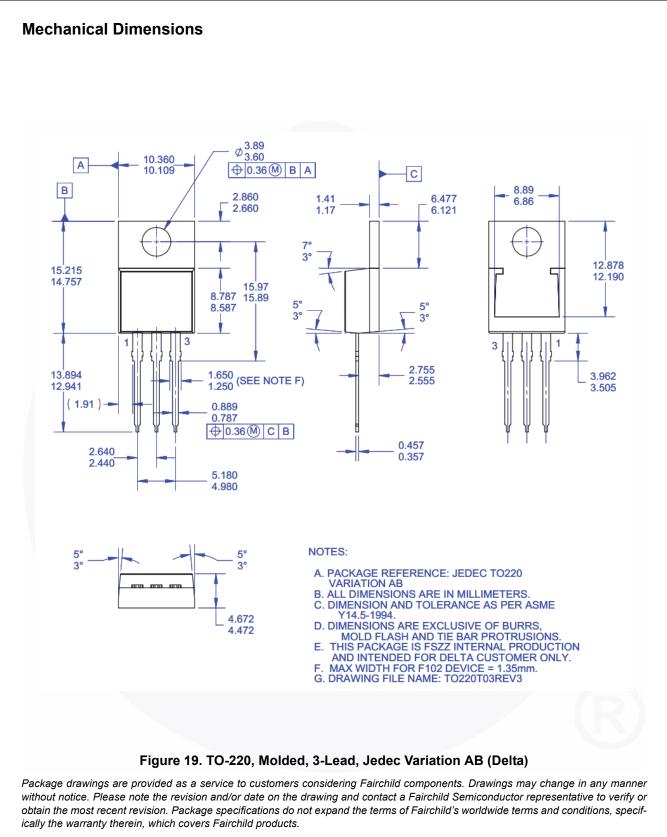


FDP039N08B — N-Channel PowerTrench<sup>®</sup> MOSFET

DUT +  $v_{DS}$ a ۱<sub>SD</sub> م L Driver R<sub>G</sub>, Same Type as DUT L F ∨<sub>DD</sub>  $\prod V_{GS}$ • dv/dt controlled by  $R_{G}$ • I<sub>SD</sub> controlled by pulse period Î Gate Pulse Width V<sub>GS</sub> D = Gate Pulse Period 10V (Driver) I<sub>FM</sub>, Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current  $V_{DS}$ (DUT) Body Diode Recovery dv/dt  $V_{SD}$ V<sub>DD</sub> Body Diode Forward Voltage Drop Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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